

## FEATURE

- Ultra thin, thickness 1.0mm
- Leadless type
- High precision characteristic covering up to high frequency range
- Automatic mounting
- Embossed taping specification
- Suitable for Reflow soldering

## APPLICATIONS

 Ideally suited designed for disc drives, NB, PCs and hand-held electronic products

# **ELECTRICAL SPECIFICATIONS**

Output Frequency Range	12.000 MHz to 40.000 MHz	
Mode	See Table 1*	
Frequency Tolerance (at 25°C)	±30ppm ~ ±50ppm, or specify	
Frequency Stability Over Operating	-10°C ~+60°C ±30ppm,	
Temperature Characteristics	-20°C ~+70°C ±50ppm or specify	
Storage Temperature Range	-55 °C to +125 °C	
Operable Temperature Range	-40 °C to + 85 °C	
Shunt Capacitance (C <sub>0</sub> )	5.0 pF Max	
Driver Level (Typical)	10µW~100µW	
Load Capacitance(C <sub>L</sub> )	Series, 16pF, 20pF, 30pF, 32pF, or	
	specify	
Equivalent Series Resistance ESR	See Table 1*	
Aging @25°C 1 <sup>st</sup> year (Max)	±3ppm, ±5ppm/year	
Shock Resistance	Drop test of 3 times on 2mm	
	stainless plate from 75cm height	
REMARK: SPECIFICATIONS SUBJECT TO CHANGE WITHOUT PRIOR NOTICE. PLEASE CONFIRM WITH OUR SALES		

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## **Frequency and Equivalent Series Resistant**

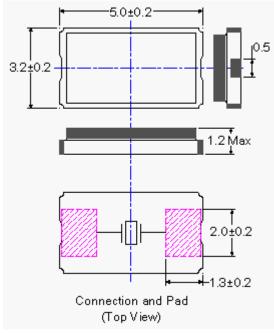
Frequency Range	<b>E.S.R.</b> (Ω)	Mode
12.000 MHz ~ 30.000 MHz	60 Max	Fundamental / AT
30.000 MHz ~ 40.000 MHz	45 Max	Fundamental / AT



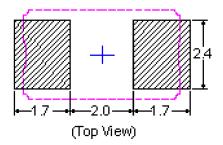
# Series TG5 GLASS SEALED <u>CERAMIC 5.0 X 3.2mm SMD</u>



#### Dimension



# **Reference Land Pattern**



# PACKING

## **Reflow Condition**

